



Examiner : Alonzo Chambliss
Art Unit : 2814
Docket No. : 52433/609

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : K. TATSUMI et al.

Serial No. : 09/632,910

Filed : August 4, 2000

For : **METHOD FOR FABRICATING A SEMICONDUCTOR DEVICE PROVIDED WITH LOW MELTING POINT METAL BUMPS**

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

TRANSMITTAL LETTER

SIR:

Transmitted herewith is an Amendment/Response in the above-identified patent application.

No additional fee is required.

The fee has been calculated as shown below.

CLAIMS REMAINING AFTER AMENDMENT	HIGHEST NO. PREVIOUSLY PAID FOR			RATE x6=	ADDET. OR FEE	OTHER THAN A SMALL ENTITY		
	8	MINUS	20			=	0	x18 =
INDEP. 2	MINUS	3	=	0	x18=	\$	0.00	
[] FIRST PRESENTATION OF MULTIPLE				x60=	\$ _____	x280=	\$ _____	
DEP. CLAIM				TOTAL				
				ADDIT. FEE	\$ _____	OR	\$ _____ 0.00	

The Commissioner is hereby authorized to charge fees under 37 CFR 1.16 and 1.17 which may be required to Deposit Account 11-0600. A duplicate of this paper is enclosed.

A petition for a one (1) month extension of time and Deposit Account authorization to cover the extension fee are enclosed.

I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on May 31, 2005.

John J. Kelly, Jr.
John J. Kelly, Jr. Reg. No. 29,182

Respectfully submitted,

KENYON & KENYON

By: *John J. Kelly, Jr.*
John J. Kelly, Jr.
Reg. No. 29,182

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RESPONSE

SIR:

Reconsideration of the above-identified patent application is respectfully requested. This response is in reply to the Office Action mailed February 1, 2005. A petition for an extension of time in which to reply to the Office Action accompanies this response.

Claims 16-19 and 25 are pending in the application. Claims 16 and 17 are

the independent claims.